

110-13-628-41-801000

110-13-628-41-801000 Information



Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.



110-13-628-41-801000 Specifications

Manufacturer Mill-Max Manufacturing Corp. Connectors, Interconnects Sockets for ICs, Transistors Package - Package 110 Speries 110 Pype DIP, 0.6" (15.24mm) Row Spacing Vumber of Positions or Pins (Grid) 28 (2 x 14) Pitch - Mating 0.100" (2.54mm) Row Spacing Contact Finish - Mating Gold Contact Finish - Mating 30µin (0.76µm) Contact Finish Thickness - Mating Beryllium Copper Contact Material - Mating Open Frame, Decoupling Capacitor Pertures Open Frame, Decoupling Capacitor Pertures Gold Contact Finish - Post Gold Contact Finish - Post Gold Contact Finish Thickness - Post I/louin (0.25µm) Contact Finish Thickness - Post Gold Contact Finish Thickness - Post I/louin (0.25µm) Contact finish Thickness - Po			
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$-55^{\circ}\text{C} \sim 125^{\circ}\text{C}$	Contact Material - Post	Brass Alloy	
	Housing Material	Polycyclohexylenedimethylene Terephthalate (PCT), Polyester	
Report errors?	Operating Temperature	-55°C ~ 125°C	
			Report errors?

110-13-628-41-801000 Guarantees



Quality Guarantees

We provide 90 days warranty. * If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.

SERVICE BUARANTEE

Service Guarantees

We guarantee 100% customer satisfaction. Our experienced sales team and tech support team back our services to satisfy all our customers.

110-13-628-41-801000 Payment Methods





If you have any question about 110-13-628-41-801000, please do not hesitate to contact us! Website: https://www.heisener.com E-mail: salesdept@heisener.com